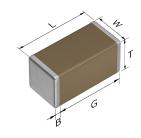
## 积层贴片陶瓷片式电容器

## C3216X6S0G107M160AC

RoHS Reach Halogen Free Pb Free

交货型号	C3216X6S0G107MT****
用途	一般等级
特点	General 一般(~75V)
系列	C3216 [EIA 1206]
状态	量产体制



尺寸		
长度(L)	3. 20mm +0. 30, -0. 10mm	
宽度(W)	1.60mm +0.30, -0.10mm	
厚度(T)	1.60mm +0.30, -0.10mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	1.00mm Min.	
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)	
1世行/汗血·仰/问 (L f.)	2.00mm to 2.40mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)	
进行产血和/问(LD)	1.00mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)	
JE 行が生血 中内 は U/	1.10mm to 1.60mm(Reflow Soldering)	

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电容	$100~\muF~\pm20\%$
额定电压	4VDC
温度特性	$X6S(\pm 22\%)$
耗散因数(Max.)	10%
	1ΜΩ

	其他	
MI +/X → - X+	流体	
焊接方法	回流	
AEC-Q200	NO	
包装形式	塑封编带(180mm卷筒)	
包装个数	2000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

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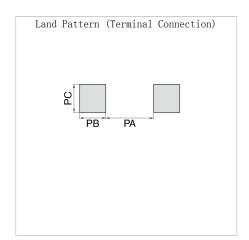
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## Associated Images



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